Voltage Detector IC Series

Bipolar

Voltage Detector ICs

BD47xx series

● General Description
The BD47xx series is a Voltage Detector IC, developed to prevent system errors at transient state, when the power of CPU or logic circuit switches ON/OFF or in cases of momentary shut down. These ICs consist of three terminals (power supply, GND and reset output) to detect power supply voltages and outputs reset signals of various systems. These ICs are ultra-compact and have low current consumption, making them ideal for portable products.

● Features
- High accuracy detection
- Low current consumption
- Very small package
- Open collector "L" reset output
- Package SSOP5 is similar to SOT-23-5 (JEDEC)

● Key Specifications
- Detection voltage range: 1.9V to 4.6V (Typ.)
- 0.1V steps
- High accuracy detection voltage: ±1%
- Low current consumption: 1.6µA (Typ.)
- Operating temperature range: -40°C to +75°C

● Package
SSOP5
2.90mm x 2.80mm x 1.25mm

● Applications
Circuits using microcontrollers or logic circuits that require a reset.

● Typical Application Circuit

● Connection Diagram
SSOP5
TOP VIEW

● Pin Descriptions

<table>
<thead>
<tr>
<th>PIN No.</th>
<th>Symbol</th>
<th>Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>N.C.</td>
<td>Unconnected Terminal</td>
</tr>
<tr>
<td>2</td>
<td>SUB</td>
<td>Substrate*</td>
</tr>
<tr>
<td>3</td>
<td>GND</td>
<td>GND</td>
</tr>
<tr>
<td>4</td>
<td>VOUT</td>
<td>Reset Output</td>
</tr>
<tr>
<td>5</td>
<td>VDD</td>
<td>Power Supply Voltage</td>
</tr>
</tbody>
</table>

*Substrate Pin should be connected with GND
**Ordering Information**

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Reset Voltage Value</th>
<th>Package</th>
<th>Packaging and Forming Specification</th>
</tr>
</thead>
<tbody>
<tr>
<td>BD47xx</td>
<td>19: 1.9V, 0.1V step</td>
<td>G: SSOP5</td>
<td>TR: Embossed tape and reel</td>
</tr>
</tbody>
</table>

**Lineup**

<table>
<thead>
<tr>
<th>Marking</th>
<th>Detection Voltage</th>
<th>Part Number</th>
<th>Marking</th>
<th>Detection Voltage</th>
<th>Part Number</th>
<th>Marking</th>
<th>Detection Voltage</th>
<th>Part Number</th>
</tr>
</thead>
<tbody>
<tr>
<td>B2</td>
<td>4.6V</td>
<td>BD4746</td>
<td>BR</td>
<td>3.6V</td>
<td>BD4736</td>
<td>BH</td>
<td>2.6V</td>
<td>BD4726</td>
</tr>
<tr>
<td>B1</td>
<td>4.5V</td>
<td>BD4745</td>
<td>BQ</td>
<td>3.5V</td>
<td>BD4735</td>
<td>BG</td>
<td>2.5V</td>
<td>BD4725</td>
</tr>
<tr>
<td>BZ</td>
<td>4.4V</td>
<td>BD4744</td>
<td>BP</td>
<td>3.4V</td>
<td>BD4734</td>
<td>BF</td>
<td>2.4V</td>
<td>BD4724</td>
</tr>
<tr>
<td>BY</td>
<td>4.3V</td>
<td>BD4743</td>
<td>B4</td>
<td>3.3V</td>
<td>BD4733</td>
<td>BE</td>
<td>2.3V</td>
<td>BD4723</td>
</tr>
<tr>
<td>BX</td>
<td>4.2V</td>
<td>BD4742</td>
<td>BN</td>
<td>3.2V</td>
<td>BD4732</td>
<td>BD</td>
<td>2.2V</td>
<td>BD4722</td>
</tr>
<tr>
<td>BW</td>
<td>4.1V</td>
<td>BD4741</td>
<td>BM</td>
<td>3.1V</td>
<td>BD4731</td>
<td>BC</td>
<td>2.1V</td>
<td>BD4721</td>
</tr>
<tr>
<td>BV</td>
<td>4.0V</td>
<td>BD4740</td>
<td>BL</td>
<td>3.0V</td>
<td>BD4730</td>
<td>BB</td>
<td>2.0V</td>
<td>BD4720</td>
</tr>
<tr>
<td>BU</td>
<td>3.9V</td>
<td>BD4739</td>
<td>BK</td>
<td>2.9V</td>
<td>BD4729</td>
<td>BA</td>
<td>1.9V</td>
<td>BD4719</td>
</tr>
<tr>
<td>BT</td>
<td>3.8V</td>
<td>BD4738</td>
<td>BJ</td>
<td>2.8V</td>
<td>BD4728</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>BS</td>
<td>3.7V</td>
<td>BD4737</td>
<td>B3</td>
<td>2.7V</td>
<td>BD4727</td>
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### Absolute maximum ratings

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Limit</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Power Supply Voltage</td>
<td>$V_{DD}$</td>
<td>-0.3 to +10</td>
<td>V</td>
</tr>
<tr>
<td>Output Voltage</td>
<td>$V_{OUT}$</td>
<td>-0.3 to +10</td>
<td>V</td>
</tr>
<tr>
<td>Output Current</td>
<td>$I_{O}$</td>
<td>60 mA</td>
<td></td>
</tr>
<tr>
<td>Power Dissipation $^{*1, *2}$</td>
<td>$P_d$</td>
<td>540 mW</td>
<td></td>
</tr>
<tr>
<td>Operation Temperature Range</td>
<td>$T_{opt}$</td>
<td>-40 to +75</td>
<td>°C</td>
</tr>
<tr>
<td>Ambient Storage Temperature</td>
<td>$T_{stg}$</td>
<td>-55 to +125</td>
<td>°C</td>
</tr>
</tbody>
</table>

$^{*1}$ Reduced by 5.4mW/°C when used over 25°C.

$^{*2}$ When mounted on ROHM standard circuit board (70mm×70mm×1.6mm, glass epoxy board).

### Electrical characteristics (Unless Otherwise Specified $T_a=25°C$)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Condition</th>
<th>Limit</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Detection Voltage</td>
<td>$V_{DET}$</td>
<td>$V_{DD}=H\rightarrow L$ $R_L=4.7k\Omega$</td>
<td>$V_{DET}(T)$×0.99 $V_{DET}(T)$×1.01</td>
<td>$V$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{DET}=2.5V$</td>
<td>$T_a=+25°C$</td>
<td>2.475</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_a=-40°C$ to +75°C</td>
<td>2.418</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{DET}=3.0V$</td>
<td>$T_a=+25°C$</td>
<td>2.970</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_a=-40°C$ to +75°C</td>
<td>2.901</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{DET}=3.3V$</td>
<td>$T_a=+25°C$</td>
<td>3.267</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_a=-40°C$ to +75°C</td>
<td>3.191</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{DET}=4.2V$</td>
<td>$T_a=+25°C$</td>
<td>4.158</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_a=-40°C$ to +75°C</td>
<td>4.061</td>
<td>-</td>
</tr>
<tr>
<td>Temperature Coefficient of Detection Voltage</td>
<td>$V_{DET}/\Delta T$</td>
<td>$R_L=4.7k\Omega$ $T_a=-20$ to +75°C Design Guarantee</td>
<td>-</td>
<td>±0.01</td>
</tr>
<tr>
<td>Detection Hysteresis Voltage</td>
<td>$\Delta V_{DET}$</td>
<td>$R_L=4.7k\Omega$, $V_{DD}=L\rightarrow H\rightarrow L$</td>
<td>30</td>
<td>50</td>
</tr>
<tr>
<td>Transfer Delay Time &quot;H&quot;</td>
<td>$t_{PLH}$</td>
<td>$C_L=100pF$, $R_L=4.7k\Omega$</td>
<td>1</td>
<td>-</td>
</tr>
<tr>
<td>Transfer Delay Time &quot;L&quot;</td>
<td>$t_{PHL}$</td>
<td>$C_L=100pF$, $R_L=4.7k\Omega$</td>
<td>2</td>
<td>-</td>
</tr>
<tr>
<td>Reset Output Voltage &quot;L&quot;</td>
<td>$V_{OL}$</td>
<td>$V_{DD}=V_{DET}(min.)-0.05V$, $R_L=4.7k\Omega$</td>
<td>-</td>
<td>0.1</td>
</tr>
<tr>
<td>Circuit Current ON</td>
<td>$I_{CC1}$</td>
<td>$V_{DD}=V_{DET}(min.)-0.05V$, $R_L=\infty$</td>
<td>-</td>
<td>1.5</td>
</tr>
<tr>
<td>Circuit Current OFF</td>
<td>$I_{CC2}$</td>
<td>$V_{DD}=V_{DET}(typ.)+0.85V$, $R_L=\infty$</td>
<td>-</td>
<td>1.6</td>
</tr>
<tr>
<td>Operating Voltage Range</td>
<td>$V_{OLP}$</td>
<td>$R_L=4.7k\Omega$, $V_{OL}\leq0.4V$</td>
<td>-</td>
<td>0.65</td>
</tr>
<tr>
<td>Output Leak Current</td>
<td>$I_{OL}$</td>
<td>$V_{DD}=V_{OUT}=10V$</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Reset Output Current &quot;L&quot;</td>
<td>$I_{OL}$</td>
<td>$V=0.4V$, $V_{DD}=V_{DET}(min.)-0.05V$</td>
<td>3.0</td>
<td>15.0</td>
</tr>
</tbody>
</table>

$V_{DET}(T)$: Standard Detection Voltage (1.9V to 4.6V, 0.1V step)

$R_L$: Pull-up resistor to be connected between $V_{OUT}$ and power supply.

$C_L$: Capacitor to be connected between $V_{OUT}$ and GND.

$^{*1}$ $t_{PLH}: V_{DD}=(V_{DET}(typ.)-0.4V) \rightarrow (V_{DET}(typ.)+0.4V)$

$^{*2}$ $t_{PHL}: V_{DD}=(V_{DET}(typ.)+0.4V) \rightarrow (V_{DET}(typ.)-0.4V)$

Design Guarantee. (Outgoing inspection is not done on all products)
Fig.1  BD47xx series
Typical Performance Curves

Fig.2 Circuit Current

Fig.3 "Low" Output Current

Fig.4 I/O Characteristics

Fig.5 Operating Limit Voltage
Typical Performance Curves – continued

**Fig. 6 Detection Voltage**

**Fig. 7 Circuit Current when ON**

**Fig. 8 Circuit Current when OFF**

**Fig. 9 Operating Limit Voltage**
Typical Performance Curves – continued

Fig. 10 Output Saturation Voltage

![Graph showing Output Voltage vs. Low Output Current for different temperatures (Ta=-20℃, Ta=25℃, Ta=75℃)]
Application Information

Explanation of Operation

BD47xx series has threshold voltages namely the detection voltage and release voltage. As the voltages applied to the input reach their respective thresholds, the output switches from “High” to “Low” and from “Low” to “High”. The release voltage has a hysteresis that is the value of the detection voltage +50mV (Typ.), preventing chattering in the output. When the input is greater than the release voltage, the output is in a “High” state. When the input decreases from that state, the output switches to “Low” upon reaching the detection voltage. When the input is less than the detection voltage, the output is in a “Low” state. When the input increases from that state, the output switches to “High” upon reaching the release voltage. Additionally, at least 0.85V input voltage is required for the circuit to function as expected. When the input falls below the operating limit voltage, the output becomes unstable.

When the power supply is turned on, the output is still unstable until it reaches the operating limit voltage ($V_{OPL}$) with a given time $t_{PHL}$. Therefore it is possible that the reset signal is not outputted when the rise time of $V_{DD}$ is faster than $t_{PHL}$.

When $V_{DD}$ is greater than $V_{OPL}$ but less than the reset release voltage ($V_{DET}+\Delta V_{DET}$), the output voltages will switch to Low.

If $V_{DD}$ exceeds the reset release voltage ($V_{DET}+\Delta V_{DET}$) then $V_{OUT}$ switches from L to H after $t_{PLH}$.

If $V_{DD}$ drops below the detection voltage ($V_{DET}$) when the power supply is powered down or when there is a power supply fluctuation, $V_{OUT}$ switches to L (with a delay of $t_{PHL}$).

The potential difference between the detection voltage and the release voltage is known as the Hysteresis Width ($\Delta V_{DET}$). The system is designed such that, the output does not toggle with power supply fluctuations within this hysteresis width, malfunctions due to noise are prevented.

<Precautions>

Please be aware that when there is resistance on the power supply line, the detection voltage varies with voltage drops caused by the IC current consumption.

Please connect a capacitor between $V_{DD}$ and GND when the power supply line has high impedance.
● Circuit Applications
The following is an example of an application circuit using Reset IC for normal power supply detection. BD47.xx series requires a pull up resistor on the output terminal. The pull up resistor value should be decided depending on the application, with enough consideration of power supply level and output current capability. When a capacitor is placed at the output terminal, to delay the output time or to remove noise, the output will become slower during starting or stopping. Please be careful in considering the appropriate value for pull up resistors, output current, and capacitor when inserting a bypass capacitor between input and GND. Please be aware that if an extremely large capacitor is used, the response time will become excessively slow.
Operational Notes

1) Absolute maximum ratings
Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

2) Ground Voltage
The voltage of the ground pin must be the lowest voltage of all pins of the IC at all operating conditions. Ensure that no pins are at a voltage below the ground pin at any time, even during transient condition.

3) Recommended operating conditions
These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

4) Bypass Capacitor for Noise Rejection
To help reject noise, put a 1µF capacitor between VDD pin and GND and 1000pF capacitor between VOUT pin and GND. Be careful when using extremely big capacitor as transient response will be affected.

5) Short between pins and mounting errors
Be careful when mounting the IC on printed circuit boards. The IC may be damaged if it is mounted in a wrong orientation or if pins are shorted together. Short circuit may be caused by conductive particles caught between the pins.

6) Operation under strong electromagnetic field
Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

7) The VDD line impedance might cause oscillation because of the detection current.

8) A VDD to GND capacitor (as close connection as possible) should be used in high VDD line impedance condition.

9) Lower than the minimum input voltage puts the VOUT in high impedance state, and it must be VDD in pull up (VDD) condition.

10) External parameters
The recommended parameter range for RL is 2kΩ to 1MΩ. There are many factors (board layout, etc) that can affect characteristics. Please verify and confirm using practical applications.

11) Power on reset operation
Please note that the power on reset output varies with the VDD rise time. Please verify the behavior in the actual operation.

12) Testing on application boards
When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC’s power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

13) Rush current
When power is first supplied to the IC, rush current may flow instantaneously. It is possible that the charge current to the parasitic capacitance of internal photo diode or the internal logic may be unstable. Therefore, give special consideration to power coupling capacitance, power wiring, width of GND wiring, and routing of connections.
Notice

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1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment, transport equipment, traffic equipment, aircraft/spacraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM’s Products for Specific Applications.

(Nota1) Medical Equipment Classification of the Specific Applications

<table>
<thead>
<tr>
<th>JAPAN</th>
<th>USA</th>
<th>EU</th>
<th>CHINA</th>
</tr>
</thead>
<tbody>
<tr>
<td>CLASS III</td>
<td>CLASS III</td>
<td>CLASS II b</td>
<td>CLASS III</td>
</tr>
<tr>
<td>CLASS IV</td>
<td></td>
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<td></td>
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</tbody>
</table>

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
[a] Installation of protection circuits or other protective devices to improve system safety
[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

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[a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
[b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
[c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
[d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
[e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
[f] Sealing or coating our Products with resin or other coating materials
[g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
[h] Use of the Products in places subject to dew condensation

4. The Products are not subject to radiation-proof design.
5. Please verify and confirm characteristics of the final or mounted products in using the Products.
6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
8. Confirm that operation temperature is within the specified range described in the product specification.
9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design
1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification.
Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.

2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
   - the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
   - the temperature or humidity exceeds those recommended by ROHM
   - the Products are exposed to direct sunshine or condensation
   - the Products are exposed to high Electrostatic

2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.

3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM’s internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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